

27 to 930MHz FSK/FM/ASK Receiver

Features

Very wide frequency coverage
Programmable PLL synthesizer
8 channels preconfigured or fully programmable SPI mode
Double super-heterodyne receiver architecture with 2 nd mixer as image rejection mixer
Reception of FSK, FM and ASK modulated signals
Low shut-down and operating currents
AGC – automatic gain control
On-chip IF filter
Fully integrated FSK/FM demodulator
RSSI for level indication and ASK detection
2 nd order low-pass data filter
Positive and negative peak detectors
Data slicer (with averaging or peak-detector adaptive threshold)
32-pin Quad Flat No-Lead Package (QFN)
EVB programming software is available on Melexis web site

Ordering Code

Product Code	Temperature Code	Package Code	Option Code	Packing Form Code
MLX71122	R	LQ	BAA-000	RE
MLX71122	R	LQ	BAA-000	TU

Legend:
Temperature Code: R for Temperature Range -40℃ to 105℃

LQ for QFN

Packing Form: RE for Reel, TU for Tube

Ordering example: MLX71122RLQ-BAA-000-RE

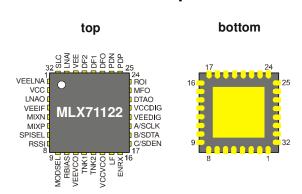


27 to 930MHz FSK/FM/ASK Receiver

Application Examples

- ☐ General digital and analog RF receivers at 27 to 930MHz
- ☐ Automatic meter reading (AMR)
- ☐ Tire pressure monitoring systems (TPMS)
- ☐ Remote keyless entry (RKE)
- □ Alarm and security systems
- Active RFID tags
- □ Remote controls
- Garage door openers
- Home and building automation

Pin Description



General Description

The MLX71122 is a multi-channel RF receiver IC based on a double-conversion super-heterodyne architecture. It is designed to receive FSK and ASK modulated RF signals either in 8 predefined frequency channels or frequency programmable via a 3-wire serial programming interface (SPI).

The IC is designed for a variety of applications, for example in the European bands at 433MHz and 868MHz or for the use in North America or Asia, e.g. at 315MHz, 447MHz or 915MHz. Thanks to its versatile voltage-controlled oscillator (VCO) design the MLX71122 can operate even at frequencies as low as 27MHz.



27 to 930MHz FSK/FM/ASK Receiver

Revision History

Revision	Date	Comment	
009	Oct 2009	First official release	
010	Dec 2009	Corrections	
011	Dec 2010	Frequency range extension (27 to 930MHz), corrections	
012	Feb 2012	Fig. 21, Fig. 22 corrected, disclaimer and phone numbers updated	
013	Jun 2012	Logo, ordering code	





Document Content

1	The	eory of Operation	7
	1.1	General	7
	1.2 T	echnical Data Overview	7
	1.3 E	Block Diagram	8
		Enable/Disable in ABC Mode	
		Demodulation Selection in ABC Mode	
		Programming Modes	
		Preconfigured Frequencies in ABC Mode	
2	Pin	Definitions and Descriptions	10
	2.1 F	Pin Schematics	10
	2.2 F	RF Pin Impedance Models	15
3	Fur	nctional Description	16
J		-	
	3.1 F	requency Planning 1 Calculation of Counter Settings	
	3.1.2	•	
	3.1.3		
	3.1.4		
	3.1.5	Counter Settings in ABC Mode – 8+1 Preconfigured Channels	20
	3.2 F	PLL Frequency Synthesizer	20
	3.2.1		21
	3.2.2	S .	
	3.2.3	· /	
	3.2.4	, ,	
	3.2.5		
	3.2.6		
	3.2.7	()	
	3.2.8 3.2.9	9	
		·	
	3.3 F	Receiver Front End	
	3.3.1 3.3.2		
	3.3.3		
	3.3.4	,	
	3.3.5		
	3.3.6	· · · · · · · · · · · · · · · · · · ·	
	3.3.7		
		Data Path	
	3.4.1		



27 to 930MHz FSK/FM/ASK Receiver

	3.	4.2	Averaging Data Slicer Mode	
	_	4.3	Peak Detectors (PKDET)	
	3.	4.4	Output Comparator	32
	3.5	Fre	quency Acceptance Range	32
	3.6	Bia	sing System	33
	3.7	Ор	erating Modes	33
	3.8	Ми	lti Functional Output	33
	3.9		I Description	
		9.1	General	
	3.	9.2	Read / Write Sequences	
	3.	9.3	Serial Programming Interface Timing	
4	R	egis	ster Description	36
	4.1	•	gister Overview	
		1.1	Control Word R0	
		1.2	Control Word R1	
	4.	1.3	Control Word R2	
		1.4	Control Word R3	
	4.	1.5	Control Word R4	
	4.	1.6	Control Word R5	
	4.	1.7	Control Word R6	
	4.	1.8	Control Word R7 (Read-only Register)	42
5	T	ech	nical Data	43
	5.1	Ab.	solute Maximum Ratings	43
	5.2		rmal Operating Conditions	
	5.3		rstal Parameters	
	5.4	•	rial Programming Interface (SPI)	
	5.5		Characteristics	
	5.6		System Characteristics	
_				
6	1		Circuits	
	6.1		Indard FSK & ASK Reception in 8-Channel Preconfigured (ABC) Mode	
	6.	1.1	Averaging Data Slicer for Bi-Phase Codes (e.g. Manchester)	47
	6.2	Sta	ndard FSK & ASK Reception in SPI Mode	48
	6	2.1	Averaging Data Slicer for Bi-Phase Codes (e.g. Manchester)	48
	6	2.2	Peak Detector Data Slicer Configured for NRZ Codes	49
	6.3	Te	st Circuit Component List	50
7	P	ack	age Description	51
	7.1		dering Information	
			······································	



27 to 930MHz FSK/FM/ASK Receiver

8	Standard information regarding manufacturability of Melexis products with different soldering processes		
9	ESD Precautions		
10	Disclaimer	54	

27 to 930MHz FSK/FM/ASK Receiver

1 Theory of Operation

1.1 General

The MLX71122 receiver architecture is based on a double-conversion super-heterodyne approach. The two LO signals are derived from an on-chip integer-N PLL frequency synthesizer. The PLL reference frequency is derived from a crystal (XTAL). The PLL synthesizer consists of an integrated voltage-controlled oscillator with external inductor, a programmable feedback divider chain, a programmable reference divider, a phase-frequency detector with a charge pump and an external loop filter.

In the receiver's down-conversion chain, two mixers MIX1 and MIX2 are driven by the internal local oscillator signals LO1 and LO2, respectively. The second mixer MIX2 is an image-reject mixer. As the first intermediate frequency (IF1) is very high (typically above 100 MHz), a reasonably high degree of image rejection is provided even without using an RF front-end filter. At applications asking for very high image rejections, cost-efficient RF front-end filtering can be realized by using a SAW filter in front of the LNA.

The receiver signal chain is set up by a low noise amplifier (LNA), two down-conversion mixers (MIX1 and MIX2), an on-chip IF filter (IFF) as well as an IF amplifier (IFA). By choosing the required modulation via an FSK/ASK switch (at pin MODSEL), either the on-chip FSK demodulator (FSK DEMOD) or the RSSI-based ASK detector is selected. A second order data filter (OA1) and a data slicer (OA2) follow the demodulator. The data slicer threshold can be generated from the mean-value of the data stream or by means of the positive and negative peak detectors (PKDET+/-).

In general the MLX71122 can be set to shut-down mode, where all receiver functions are completely turned off, and to several other operating modes. There are two global operating modes that are selectable via the logic level at pin SPISEL:

8-channel pre-configured mode (**ABC mode**) fully programmable mode (**SPI mode**).

In ABC mode the number of frequency channels is limited to eight but no microcontroller programming is required. In this case the three lines of the serial programming interface (SPI) are used to select one of the eight predefined frequency channels via simple 3-bit parallel programming. Pins ENRX and MODSEL are used to enable/disable the receiver and to select FSK or ASK demodulation, respectively.

SPI mode is recommended for full programming flexibility. In this case the three lines of the SPI are configured as a standard 3-wire bus (SDEN, SDTA and SCLK). This allows changing many parameters of the

receiver, for example more operating modes, channels, frequency resolutions, gains, demodulation types, data slicer settings and more. The pin MODSEL has no effect in this mode.

1.2 Technical Data Overview

Input frequency ranges: 27 to 930MHz	Minimum frequency resolution: 10kHz
Power supply range: 3.0 to 5.5V	Total image rejection: > 65dB (with external
Temperature range: -40 to +110 ℃	RF front-end filter)
Shutdown current: 50nA	FSK/FM deviation range: ±10 to ±50kHz
Operating current: 12mA (typ.)	Spurious emission: < -70dBm
FSK input sensitivity: -107dBm (typ.)	Linear RSSI range: > 50dB
ASK input sensitivity: -112dBm (typ.)	FSK input frequency acceptance range:
Internal IF2: 2MHz with 230kHz 3dB bandwidth	180kHz (3dB sensitivity loss)
Maximum data rate: 100kbps NRZ code,	Crystal reference frequency: 10MHz
50kbps bi-phase code	



1.3 Block Diagram

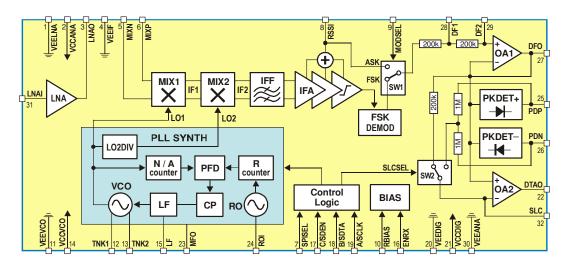


Fig. 1: MLX71122 block diagram

The MLX71122 receiver IC consists of the following building blocks:

- PLL synthesizer (PLL SYNTH) to generate the first and second local oscillator signals LO1 and LO2, parts of the PLL SYNTH are the voltage-controlled oscillator (VCO), the feedback dividers N/A and R, the phase-frequency detector (PFD), the charge pump (CP) and the crystal-based reference oscillator (RO)
- Low-noise amplifier (LNA) for high-sensitivity RF signal reception
- First mixer (MIX1) for down-conversion of the RF signal to the first IF (intermediate frequency)
- Second mixer (MIX2) with image rejection for down-conversion from the first to the second IF
- IF Filter (IFF) with a 2MHz center frequency and a 230kHz 3dB bandwidth
- IF amplifier (IFA) to provide a large amount of voltage gain and an RSSI signal output
- FSK demodulator (FSK DEMOD)
- Operational amplifiers OA1 and OA2 for low-pass filtering and data slicing, respectively
- Positive (PKDET+) and negative (PKDET-) peak detectors
- Switches SW1 to select between FSK and ASK as well as SW2 to chose between averaging or peak detector data slicer
- Control logic with 3-wire bus serial programming interface (SPI)
- Biasing circuit with modes control

27 to 930MHz FSK/FM/ASK Receiver

1.4 Enable/Disable in ABC Mode

ENRX	Description	
0	Shutdown mode	
1	Receive mode	

Pin ENRX is pulled down internally. Device is in shutdown by default, after power supply on.

If ENRX = 0 and SPISEL = 1 then operating modes according to OPMODE bit (refer to control word R0).

If ENRX = 1 then OPMODE bit has no effect (hardwired receive mode).

1.5 Demodulation Selection in ABC Mode

MODSEL	Description
0	FSK demodulation
1	ASK demodulation

Pin MODSEL has no effect in SPI mode (SPISEL = 1). We recommend connecting it to ground to avoid a floating CMOS gate.

1.6 Programming Modes

SPISEL	Description	
0	ABC mode (8 channels preconfigured)	
1	SPI mode (programming via 3-wire bus)	

1.7 Preconfigured Frequencies in ABC Mode

Α	В	С	Receive Frequency
0	0	0	FSK1: 369.5 MHz
0	1	0	FSK5: 388.3 MHz
1	0	0	FSK2: 371.1 MHz
1	1	0	FSK4: 376.9 MHz
0	0	1	FSK3: 375.3 MHz
0	1	1	FSK7: 394.3 MHz
1	0	1	FSK6: 391.5 MHz
1	1	1	FSK8: 395.9 MHz

As all pins, pins A, B, and C are equipped with ESD protection diodes that are tied to VCC and to VEE. Therefore these pins should not be directly connected to positive supply (a logic "1") before the supply voltage is applied to the IC. Otherwise the IC will be supplied through these control lines and it may enter into an unpredictable mode. In case the user wants to apply a positive supply voltage to these pins before the supply voltage is applied to the IC, a protection resistor should be inserted in each control line.



2 Pin Definitions and Descriptions

2.1 Pin Schematics

Pin No.	Name	I/O Type	Functional Schematic	Description
1	VEELNA	ground	□ VCC □	ground of LNA core
31	LNAI	analog input	LNAI 1 1 VEELNA VEELNA	LNA input, approx. 27Ω single-ended
3	LNAO	analog output	LNAO LNAO VEE	LNA open-collector output, to be connected to external LC tank that resonates at RF
2	VCCANA	supply		positive supply of LNA, MIX1 MIX2, IFF, IFA, FSK DEMOD, OA1, OA2, PKDET+, PKDET- and BIAS
4	VEEIF	ground		negative supply of LNA, MIX1 MIX2, IFF, IFA, and FSK DEMOD
5	MIXN	analog input	MIXN bias VCC	mixer 1 negative input
6	MIXP	analog input	5 390µА VEE VEE	mixer 1 positive input
7	SPISEL	CMOS input	SPISEL 120 VEE	SPI select input
8	RSSI	analog output	RSSI 120 ASK SWI VEE	RSSI output, approx. 25kΩ
9	MODSEL	CMOS input	MODSEL 120 VEE	demodulation select input (FSK or ASK demodulation)



27 to 930MHz FSK/FM/ASK Receiver

Pin No.	Name	I/O Type	Functional Schematic	Description
10	RBIAS	analog I/O	RBIAS VCC VCC PICE VCC VCC PICE VCC VCC VCC VCC VCC VCC VCC VCC VCC V	external resistor for voltage and current biasing, $30k\Omega$ by default, to provide stable parameters over temperature and supply variations
11	VEEVCO	ground		ground of VCO
12	TNK1	analog I/O	TNK1 VD VD TNK2	VCO collector output, connection 1 to external LC tank
13	TNK2	analog I/O	VEE VEE	VCO collector output, connection 2 to external LC tank
15	LF	analog I/O	VCC VCO VCC VCC	charge pump output, connection to external loop filter
14	VCCVCO	supply		positive supply of VCO
16	ENRX	CMOS input	VCC 120 VEE	enable/disable control input (with internal pull-down)

27 to 930MHz FSK/FM/ASK Receiver

Pin No.	Name	I/O Type	Functional Schematic	Description
17	C/SDEN	CMOS input	C/SDEN 120 VEE	frequency control line C or SPI control line SDEN
18	B/SDTA	CMOS input	B/SDTA 120 VEE	frequency control line B or SPI control line SDTA
19	A/SCLK	CMOS input	A/SCLK 120 VEE	frequency control line A or SPI control line SCLK
20	VEEDIG	ground		ground of PLL SYNT (except of VCO), Control Logic, and OA2 out stage
21	VCCDIG	supply		positive supply of PLL SYNT (except of VCO), Control Logic, RO and OA2 out stage
22	DTAO	CMOS output	DTAO OA2	data output, 2mA sink or source capability



croelectronic Integrated Systems FSK/FM/ASK Receiver

Pin No.	Name	I/O Type	Functional Schematic	Description
23	MFO	analog output (option 1)	VCC	multifunctional output: reference oscillator output selected (default setting) (see 4.1.4)
23	MFO	analog output (option 2)	VCC	multifunctional output: IF2 signal output selected (see 4.1.4)
23	MFO	digital output tristate (option 3)	MFO VCC P	multifunctional output: digital output signal selected (see 4.1.4)
24	ROI	analog input	ROI 30p 30p 30p VEE	reference oscillator input for connecting an external crystal, Colpitts type oscillator with internal feedback capacitors

27 to 930MHz FSK/FM/ASK Receiver

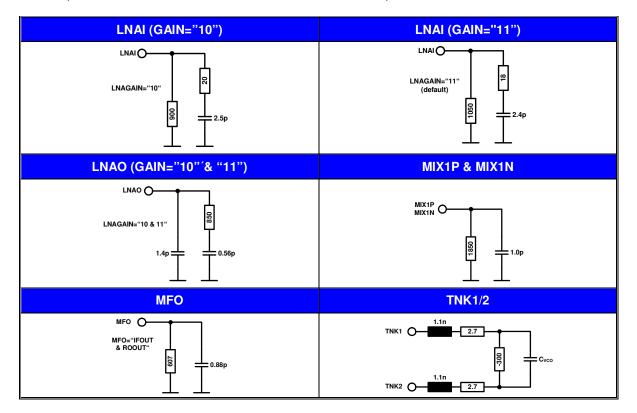
Pin No.	Name	I/O Type	Functional Schematic	Description
25	PDP	analog I/O	PDP 120 VCC	peak detector positive output for connecting an external capacitor
26	PDN	analog I/O	PDN 120 VEE	peak detector positive output for connecting an external capacitor
27	DFO	analog output	DFO VCC OA1 27 VEE VEE	data filter output
28	DF1	analog I/O	DF1 200K SW1 ASK 28 VEE SW1 FSK	data filter connection 1 for connecting an external capacitor
29	DF2	analog I/O	DF2 OA1 VEE	data filter connection 2 for connecting an external capacitor
30	VEEANA	ground		ground of RO, OA1, OA2, PKD+, PKD- and BIAS
32	SLC	analog I/O	SLC 120 WZ OA2 VEE OA2	slicer reference input for connecting an external capacitor



2.2 RF Pin Impedance Models

The following table gives the typical equivalent circuits modelling the impedance of the RF pins including the package but without the PCB parasitics.

The LNA, MIX1 and TNK1/2 models are valid from 300 to 930MHz, the MFO model is valid from 1 to 10MHz.



V _{LF} / V	VCORANGE=0 VCC=3V C _{VCO} / pF	VCORANGE=1 VCC=5V C _{VCO} / pF
0.0	6.50	6.20
0.5	6.40	6.10
1.0	6.10	6.05
1.5	4.80	5.75
2.0	3.60	5.10
2.5	3.05	4.40
3.0	2.80	3.75
3.5	-	3.20
4.0	-	2.65
4.5	-	2.45
5.5	-	2.35

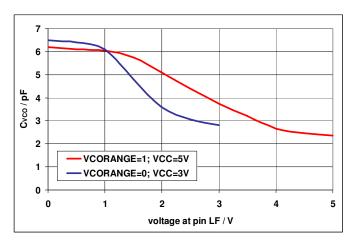


Fig. 2: C-V tuning characteristic of the VCO

The C-V characteristics for other supply voltages than given above can be derived by shifting the right end of the curves to the desired supply voltage, since the VCO frequency depends on V_{CC} - V_{LF} .

FSK/FM/ASK Receiver



3 Functional Description

3.1 Frequency Planning

Because of the double conversion architecture that employs two mixers and two IF signals, there are four different combinations for injecting the LO1 and LO2 signals:

As a result, four different input frequencies could produce the same second IF (IF2). This may seem like a problem, but being able to select high or low side injection makes it possible to avoid interference from undesired signals. This can not be done with the more common receivers which are single conversion with a low IF frequency. It is also often possible with the MLX71122 to use a simple RF filter to get better image rejection than low IF receivers which have an image reject mixer.

Referring to the block diagram in fig.1, the following equations apply:

$$f_{\mathit{IF2}} = 2.0 \mathit{MHz}$$
 , $N_{\mathit{LO2}} = \mathsf{LO2DIV} = 4$ or 8 $f_{\mathit{IN}} = \mathsf{desired}$ RF signal frequency

LO1 on high side:
$$f_{VCO} - f_{IN} = f_{IF1}$$
 LO2 on high side: $\frac{f_{VCO}}{N_{IO2}} - f_{IF1} = 2.0 MHz$

$$\text{LO1 on low side: } f_{\mathit{IN}} - f_{\mathit{VCO}} = f_{\mathit{IF1}}$$

$$\text{LO2 on low side: } f_{\mathit{IF1}} - \frac{f_{\mathit{VCO}}}{N_{\mathit{IO2}}} = 2.0 MHz$$

From these seven equations, we get:

LO1 high side and LO2 high side:
$$f_{VCO} = (f_{IN} - 2MHz) \frac{N_{LO2}}{N_{LO2} - 1}$$
 (1)

LO1 high side and LO2 low side:
$$f_{VCO} = (f_{IN} + 2MHz) \frac{N_{LO2}}{N_{LO2} - 1}$$
 (2)

LO1 low side and LO2 high side:
$$f_{VCO} = (f_{IN} + 2MHz) \frac{N_{LO2}}{N_{LO2} + 1}$$
 (3)

LO1 low side and LO2 low side:
$$f_{VCO} = (f_{IN} - 2MHz) \frac{N_{LO2}}{N_{LO2} + 1}$$
 (4)

Fig. 3 on the next page shows the 4 possible RF frequencies when receiving at f_{RF High-High} is desired.

Example:

Let
$$f_{IN}=315MHz$$
 and $N_{LO2}=4$. From (1) we get $f_{VCO}=(315MHz-2MHz)\frac{4}{4-1}=417.33MHz$ and further $f_{IF1}=102.33MHz$, $f_{LO2}=104.33MHz$ and the 2nd IF frequency is 2.0MHz.

The image frequencies of the two mixers are now:



 $f_{\it MIX\,1IMAGE} = 417.33 + 102.33 = 519.66 MHz \,, \, {\rm RF} \,\, {\rm response}, \, {\rm suppressed} \,\, {\rm by} \,\, {\rm the} \,\, {\rm RF} \,\, {\rm bandpass} \,\, {\rm filter}, \\ f_{\it MIX\,2IMAGE} = 104.33 + 2.0 = 106.33 MHz \,, \, {\rm suppressed} \,\, {\rm by} \,\, {\rm the} \,\, {\rm image} \,\, {\rm rejection} \,\, {\rm of} \,\, {\rm mixer} \,\, 2.$

 $f_{MIX\,2IMAGE}$ leads to two further RF response frequencies:

417.33 - 106.33 = 311.00MHz: suppressed by 30dB of the image rejection of mixer 2 417.33 + 106.33 = 523.66MHz: suppressed by 30dB of mixer 2 plus the RF bandpass filter

In the example of Fig. 3, the image signals at 519.66 and 523.66 are suppressed by the bandpass characteristic provided by the RF front-end. The bandpass shape can be achieved either with a SAW filter (featuring just a couple of MHz bandwidth), or by the tank circuits at the LNA input and output (this typically yields 30 to 60MHz bandwidth). In any case, the high value of the first IF (IF1) helps to suppress the image signals at $f_{\text{RF Low-High}}$ and $f_{\text{RF Low-Low}}$.

The two remaining signals at IF1 resulting from 102.33 and 106.33 enter the second mixer MIX2. This mixer features image rejection with so-called single-sideband (SSB) selection. This means either the upper or lower sideband of IF1 can be selected. In the example of Fig. 3, LO2 high-side injection has been chosen to select the IF2 signal resulting from $f_{RF High-High}$.

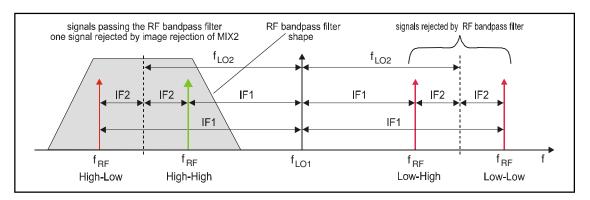


Fig. 3: The four receiving frequencies in a double conversion superhet receiver

It should be mentioned that each high-side injection mixing mirrors the frequency spectrum of the input signal. Only Low-Low and High-High injection mixing preserve the spectrum or in other words a higher frequency at RF remains a higher frequency at IF2. The polarity of the data slicer can be switched in order to compensate this for FSK reception of digital data.

It can be seen from the block diagram of Fig. 1 that there is a fixed relationship between the LO1 signal frequency f_{LO1} and the LO2 signal frequency f_{LO2} .

LO2DIV =
$$N_{LO2} = \frac{f_{LO1}}{f_{LO2}}$$
 (5)

The LO1 signal frequency f_{LO1} is directly synthesized from the crystal reference oscillator frequency f_{RO} by means of an integer-N PLL synthesizer. The PLL consists of a dual-modulus prescaler (P/P+1) with P=32, a program counter N and a swallow counter A.

$$f_{LO1} = \frac{f_{RO}}{R}(N \cdot P + A) = f_{PFD}(N \cdot P + A) = f_{PFD} \cdot N_{tot}$$
(6)



Since $LO2 = \frac{LO1}{4 \, or \, 8}$, the channel frequency step, f_{CH} , is **not** equal to the phase-frequency detector (PFD) frequency f_{PFD} .

For LO2 high-side injection, the channel step size f_{CH} is given by

$$f_{CH} = \frac{f_{RO}}{R} \frac{N_{LO2} - 1}{N_{LO2}} = f_{PFD} \frac{N_{LO2} - 1}{N_{LO2}} , \qquad (7)$$

while the following equation is valid for LO2 low-side injection:

$$f_{CH} = \frac{f_{RO}}{R} \frac{N_{LO2} + 1}{N_{LO2}} = f_{PFD} \frac{N_{LO2} + 1}{N_{LO2}}$$
 (8)

3.1.1 Calculation of Counter Settings

Frequency planning and the selection of the MLX71122's PLL counter settings are straightforward and can be laid out on the following procedure.

For this type of counter, it is necessary that A < N.

For discrete frequency tuning without equal channel steps:

Find a combination of R, A and N to obtain f_{VCO} from equations (1), (2), (3) or (4). A large value for R is not always necessary to get high resolution tuning. A combination of N_{TOT} and R can almost always be found which will give sufficient frequency accuracy even with a high PLL reference frequency. For example, 433.92MHz can be tuned with a 10MHz crystal with R = 17 and $N_{TOT} = 979$ with an 8.3kHz error.

For equal channel steps without gaps:

It is necessary that
$$N \ge P$$
, it follows $(NP + A) \ge P^2$, so $N \ge 32$ and $NP + A = N_{tot} \ge 1024$. (9)

3.1.2 Calculation of LO1 and IF1 frequency for Low Frequency Bands

High-high or high-low injection can be used for the low frequency bands. If equal channel steps are desired, choose a PFD frequency f_{PFD} according to the table below. The R counter values are valid for a 10MHz crystal reference frequency f_{RO} . The PFD frequency is given by $f_{PFD} = f_{RO}/R$.

Injection Type	f _{CH} [kHz]	f _{PFD} [kHz]	R
h-h	10	13.3	750
h-h	12.5	16.7	600
h-h	20	26.7	375
h-h	25	33.3	300
h-h	50	66.7	150
h-h	100	133.3	75
h-h	250	333.3	30

27 to 930MHz FSK/FM/ASK Receiver

The second step is to calculate the missing parameters f_{LO1} , f_{IF1} , N_{tot} , N and A. While the second IF (f_{IF2}), the N_{LO2} divider ratio and the prescaler divider ratio P are bound to $f_{IF2} = 2MHz$, $N_{LO2} = 4$ (or 8) and P = 32.

$$f_{LO1} = \frac{N_{LO2}}{N_{LO2} - 1} (f_{RF} - f_{IF2}) f_{LO1} = \frac{4}{3} (f_{RF} - 2MHz)$$
 (10)

$$f_{IFI} = \frac{f_{RF} - N_{LO2} f_{IF2}}{N_{LO2} - 1} \qquad f_{IFI} = \frac{f_{RF} - 8MHz}{3}$$
 (11)

Finally N and A can be calculated with equation (6).

3.1.3 Calculation of LO1 and IF1 frequency for High Frequency Bands

Typical ISM band operating frequencies like 868.3 and 915MHz can be covered without changing the crystal or the VCO inductor. Low-low injection is usually used for the high frequency bands. If equal channel steps are desired, choose a PFD frequency f_{PFD} according to the table below. The R counter values are valid for a 10MHz crystal reference. The PFD frequency is given by $f_{PFD} = f_{RO}/R$.

Injection Type	f _{CH} [kHz]	f _{PFD} [kHz]	R
I-I	20	16	625
I-I	25	20	500
I-I	50	40	250
I-I	100	80	125
I-I	250	200	50
I-I	500	400	25

The second step is to calculate the missing parameters f_{LO1} , f_{IF1} , N_{tot} , N and A. While the second IF (f_{IF2}), the N_{LO2} divider ratio and the prescaler divider ratio P are bound to $f_{IF2} = 2MHz$, $N_{LO2} = 4$ (or 8) and P =32.

$$f_{LO1} = \frac{N_{LO2}}{N_{LO2} + 1} (f_{RF} - f_{IF2}) f_{LO1} = \frac{4}{5} (f_{RF} - 2MHz)$$
 (12)

$$f_{IFI} = \frac{f_{RF} + N_{LO2} f_{IF2}}{N_{LO2} + 1} \qquad f_{IFI} = \frac{f_{RF} + 8MHz}{5}$$
 (13)

Finally N and A can be calculated with equation (6).

3.1.4 Counter Setting Examples for SPI Mode

To provide some examples, the following table shows some counter settings for the reception of the well-known ISM and SRD frequency bands. The channel spacing is assumed to be $f_{CH} = 100 kHz$. In below table all frequency units are in MHz.

lnj	f _{RF}	f _{IF1}	f _{LO1}	N _{tot}	N	Р	Α	f _{PFD}	R	f _{REF}	f_{LO2}	f _{IF2}
h-h	300	97.3	397.3	2980	93	32	4	0.133	75	10	99.3	2
h-h	315	102.3	417.3	3130	97	32	26	0.133	75	10	104.3	2
h-h	434	142	576	4320	135	32	0	0.133	75	10	144	2
h-h	470	154	624	4680	146	32	8	0.133	75	10	156	2
-	850	171.6	678.4	8480	256	32	0	0.08	125	10	169.6	2
-	868	175.2	692.8	8660	270	32	20	0.08	125	10	173.2	2
-	915	184.6	730.4	9130	285	32	10	0.08	125	10	182.6	2
I-I	930	187.6	742.4	9280	290	32	0	0.08	125	10	185.6	2



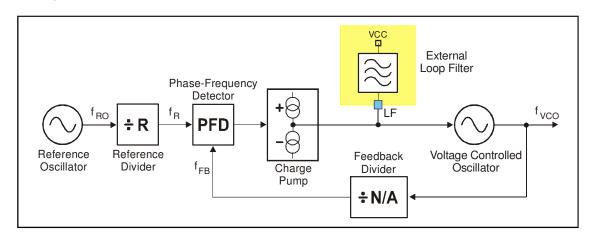
Counter Settings in ABC Mode – 8+1 Preconfigured Channels

In ABC mode (SPISEL=0), the counter settings are hard-wired. In below table all frequency units are in MHz.

CH	Inj	f _{RF}	f _{IF1}	f _{LO1}	N _{tot}	N	Р	Α	f _{PFD}	R	f _{REF}	f _{LO2}	f _{IF2}
1	h-l	369.5	125.8	495.3	3715	116	32	3	0.133	75	10	123.8	2
2	h-l	371.1	126.4	497.5	3731	116	32	19	0.133	75	10	124.4	2
3	h-l	375.3	127.8	503.1	3773	117	32	29	0.133	75	10	125.8	2
4	h-l	376.9	128.3	505.2	3789	118	32	13	0.133	75	10	126.3	2
5	h-l	384.0	130.7	514.7	3860	120	32	20	0.133	75	10	128.7	2
6	h-l	388.3	132.1	520.4	3903	121	32	31	0.133	75	10	130.1	2
7	h-l	391.5	133.2	524.7	3935	122	32	31	0.133	75	10	131.2	2
8	h-l	394.3	134.1	528.4	3963	123	32	27	0.133	75	10	132.1	2
9	h-l	395.9	134.6	530.5	3979	124	32	11	0.133	75	10	132.6	2

PLL Frequency Synthesizer

The MLX71122 contains an integer-N PLL frequency synthesizer. The reference frequency f_B is derived from a stable crystal reference oscillator.



Integer-N PLL Frequency Synthesizer Topology

The locked state of the PLL is defined by the following relations:

$$\frac{f_{RO}}{R} = f_{R} = f_{PFD} = f_{FB} = \frac{f_{VCO}}{N_{tot}} = \frac{f_{VCO}}{N \cdot P + A}.$$
 (14)

In this formula the total PLL feedback divider ratio is called N_{tot} . The synthesized output frequency f_{VCO} can be changed by reprogramming the reference divider or the feedback divider according to

$$f_{\text{VCO}} = N_{\text{tot}} \frac{f_{\text{RO}}}{R} = \left(N \cdot P + A\right) \frac{f_{\text{RO}}}{R}.$$
 (15)

The R counter is used to set the channel spacing. Different channels can be selected by changing the total feedback divider ratio.



	List of Mathematical Acronyms				
A divider ratio of the swallow counter (part of feedback divider)					
f_{FB}	frequency at the feedback divider output				
floor (x)	The floor function gives the largest integer less than or equal to x. For example, floor(5.4) gives 5, floor(-6.3) gives -7.				
f_{PFD}	PFD frequency in locked state				
$\frac{f_{RO}}{R} = f_R$	reference frequency of the PLL				
f_{RO}	frequency of the crystal reference oscillator				
f_{VCO}	frequency of the VCO (equals the LO1 signal of the first mixer)				
$N_{tot} = N \cdot P + A$	total divider ratio of the PLL feedback path				
N	divider ratio of the program counter (part of feedback divider)				
N _{LO2}	LO2DIV divider ratio, to derive the LO2 signal from LO1 ($N_1 = 4$ or 8)				
P	divider ratio of the prescaler (part of feedback divider)				
R	divider ratio of the reference divider R				

3.2.1 Pulse Swallow Counter

The programmable feedback divider of the PLL is based on a pulse-swallow topology. Fig. 5 depicts its implementation, consisting of a dual-modulus prescaler, an RS latch and two programmable counters.

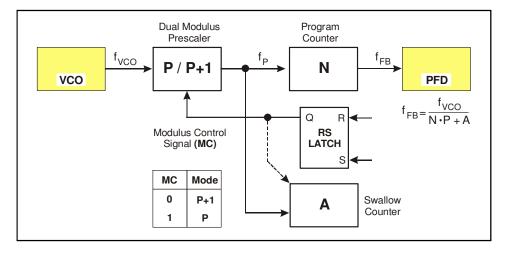


Fig. 5 Pulse Swallow Counter Topology

During one cycle of f_{FB} the prescaler begins the operation by dividing by P+1 until the swallow counter A is full. The RS latch is then set and changes the prescaler modulus to P (via the modulus control signal MC) and disables the swallow counter. The division process continues until the program counter N is full and the RS latch is reset.



A cycles of f_p (N-A) cycles of f_p MC

Fig. 6 Pulse Swallow Divider Timing

Therefore the overall feedback divide ratio is:

$$(P+1)\cdot A + P\cdot (N-A) = N\cdot P + A. \tag{16}$$

Further restrictions can be derived from above equation: A < P and A < N. Some math shows that for uniform frequency steps without gaps $(N \ge P)$ the following condition is necessary:

$$\mathbf{N} \cdot \mathbf{P} + \mathbf{A} \ge \mathbf{P} \cdot \mathbf{P} \,. \tag{17}$$

3.2.2 PLL Counter Ranges

In order to cover the frequency range of about 27 to 930MHz the following counter values are implemented in the receiver:

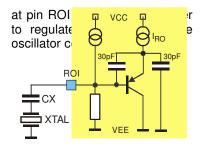
PLL Counter Ranges							
Α	N	R	Р				
0 to 31 (5bit)	3 to 2047 (11bit)	3 to 2047 (11bit)	32				

Therefore the minimum and maximum divider ratios for uniform frequency steps are given by:

$$N_{totmin} = 32 \cdot 32 = 1024$$
 $N_{totmax} = 2047 \cdot 32 + 31 = 65535$

3.2.3 Reference Oscillator (RO)

The reference oscillator is based on a Colpitts topology with two integrated functional capacitors as shown in figure 7. The circuitry is optimized for a load capacitance range of 10pF to 15pF. The equivalent input capacitance CRO offered by the oscillator input pin ROI is about 15pF. To ensure a fast and reliable start-up and a very stable frequency over the specified supply voltage and temperature range, the oscillator bias circuitry provides an amplitude regulation. Via SPI it is possible to adjust the typical core current with register ROCUR. There are four values available (see 4.1.7). At the default setting $355\mu A$, the amplitude



27 to 930MHz FSK/FM/ASK Receiver

Fig.7: RO schematic

3.2.4 Phase-Frequency Detector (PFD)

The phase-frequency detector (in conjunction with the charge pump) generates a voltage step at the loop filter pin LF. This voltage step is proportional to the phase difference between the digital input signals f_R and f_{FB} . The implementation of the phase detector is phase-frequency type. This circuitry is very useful because it decreases the acquisition time significantly even if both frequencies differ very much. The phase-frequency detector creates Up and Down signals that control the charge pump and that are also used for the lock detection circuit. The first rising edge of one of the input signals, after a reset of Up and Down, sets either the Up or the Down signal from LOW to HIGH. The following rising edge of the other signal resets Up and Down. If the register setting PFDPOL (see 4.1.2) is HIGH, the PFD polarity is positive. This means a rising edge of the signal f_R sets Up from LOW to HIGH and a rising edge of the signal f_{FB} sets Down from LOW to HIGH. If PFDPOL is LOW, the PFD polarity is negative and the assignment of Up and Down to the signals f_R and f_{FB} is swapped.

In the MLX71122 receiver the VCO frequency increases if the loop filter output voltage increases and vice versa. The PFD polarity needs to be positive to achieve the correct feedback in the PLL loop. If an external varactor diode is added to the VCO tank, the tuning characteristic may change from positive to negative depending on the particular varactor diode circuitry. Therefore the PFDPOL bit can be used to define the phase-frequency detector polarity.

3.2.5 Charge Pump (CP)

The Charge Pump is controlled by the Up and Down signals of the Phase-Frequency Detector. If the Up signal is HIGH, then the charge pump current I_{CP} is sourced from the positive supply rail to the loop filter pin LF (pin 15). If the Down signal is HIGH, then the current I_{CP} is drained from pin LF to ground. The gain of the phase detector in conjunction with the charge pump can be expressed as:

$$K_{PD} = \frac{I_{CP}}{2\pi} , \qquad (18)$$

whereas I_{CP} is the charge pump current which is set via register CPCUR (see 4.1.2). Default of I_{CP} is 100μ A. The static Up and Down selections of I_{CP} can be used for test purposes.

27 to 930MHz FSK/FM/ASK Receiver

3.2.6 Loop Filter (LF)

Since the loop filter has a strong impact on the function of the PLL, it must be chosen carefully. The suggested filter topology is shown in Fig. 8.

The loop filter of the PLL is set up by an external resistor and two external capacitors. It constitutes a 2nd order passive filter. This approach allows the user to easily adapt the loop filter bandwidth to different requirements. As a rule of thumb the loop filter bandwidth of an integer-N PLL should be set 10 times smaller than the PFD frequency. This is to achieve a stable PLL with a flat VCO noise floor.

The loop filter bandwidth depends on the external resistor and capacitors as well as on the VCO gain, the charge pump current and the so-called phase margin. A phase margin of 45° is commonly used for highest PLL stability. It is recommended to follow the component lists of section 6 for choosing appropriate values of the loop filter resistor and capacitors.

A good source for a detailed PLL analysis is: "Gardner, F.M., Phase-Locked Loop Techniques, John Wiley & Sons, 1980."

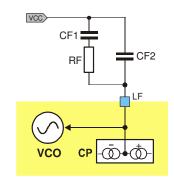
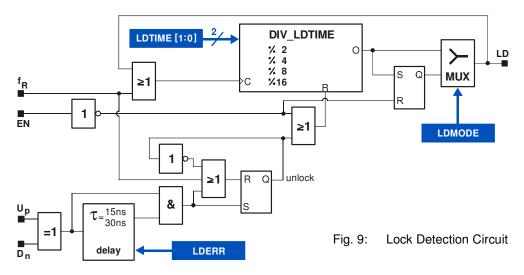


Fig. 8: 2nd order Loop filter

3.2.7 Lock Detector (LD)

In SPI mode a lock-detect signal LD is available at pin 23 if MFO is set to 1000 (binary) in control word R3 (see 4.1.4). The pin output is HIGH when the PLL is locked in. Alternatively the lock-detect signal is visible in bit 10 of R7 (see 4.1.8) if bit SHOWLD in R1 (see 4.1.2) is HIGH. The lock detection circuitry uses the Up and Down signals from the phase-frequency detector to check them for phase coherency. Figure 9 shows an overview of the lock signal generation. The locked state and the unlock condition will be controlled by the register settings of LDTIME and LDERR. During the start-up phase of the PLL, Up and Down signals are quite unbalanced. Therefore the Lock Detector circuit waits the time span that is programmed in divider DIV_LDTIME before a first lock can occur. The time span is dependent on the period of the reference signal f_R . By default it is $16/f_R$ (see 4.1.2). When the PLL approaches steady state, the signals Up and Down begin to overlap. The time span within which the signals are not overlapping is assessed by using a programmable delay gate. If it is shorter than programmed in LDERR (see 4.1.2) then the LD output is set to HIGH. By default the error time should be shorter than 15ns. A second option is shorter than 30ns.

After LD is set to HIGH the divider is disabled and the lock state remains unchanged until the unlock signal resets the divider.



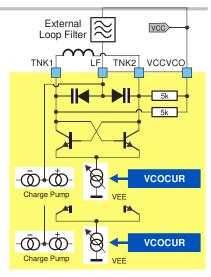


27 to 930MHz FSK/FM/ASK Receiver

3.2.8 Voltage Controlled Oscillator (VCO)

The receiver includes an LC-based voltage controlled oscillator with an external inductor connected between pins TNK1 and TNK2. Two internal varactor diodes in series combination are forming the tuneable part of the oscillator tank. The oscillation frequency is adjusted by the DC voltage at pin LF. The tuning sensitivity of the VCO is approximately 83MHz/V for 433MHz operation and 105MHz/V at 868MHz, respectively. Since the cathodes of the varactors are tied to VCC, a higher voltage at pin LF or an Up-signal of the PFD forces the capacitance to decrease and the VCO frequency to increase. With positive phase detector polarity (PFDPOL = HIGH) the edges of the signal f_{FB} will catch up to the reference signal f_{FB} (see Fig. 4).

The VCO current VCOCUR can be adjusted via the SPI in order to ensure stable oscillations over the whole frequency range. Also the bias current of the output buffer can be increased with VCOBUF to enhance its driving capability at the high frequency bands above 800MHz (see section 4.1.2). If the supply voltage is lower than 5V it is possible to adjust the tuning range of the VCO with VCORANGE (see 4.1.2). The minimum supply voltage is 3V.



3.2.9 Loop Filter Calculation

The values of the loop filter elements depend on several parameters which are the:

- peak charge pump current, I_{CP}
- VCO gain, K_{VCO}
- desired phase margin of the open PLL loop transfer function, Φ_{M}
- desired closed PLL loop bandwidth, f_C
- the feedback divider ratio, N

The peak charge pump current of the MLX71122 can be set to 100µA or 400µA (see 4.1.2).

The VCO gain depends on the external tank inductor L0 and the VCORANGE setting (see 4.1.2). The following table gives typical VCO gain values of the evaluation boards together with the frequency band.

	Typical VCO Gain							
Band / MHz	L0 inductor / nH	K _{VCO} / MHz/V, VCCRANGE=0	K _{VCO} / MHz/V, VCCRANGE=1					
27	1500	3	1.5					
315	33	128	60					
434	22	188	85					
868	5.6	222	108					
915	5.6	250	116					

The phase margin Φ_M determines the stability of the PLL. It should be larger than 45°. A phase margin of 56.4° should be preferred.

The closed loop PLL bandwidth $f_{\rm C}$ of a receiver should be as large as possible in order to allow fast settling of the frequency. On the other hand it should be so low that the reference spurs at the PFD frequency are sufficiently suppressed. A good compromise is to make $f_{\rm C}$ 1/10 of the PFD frequency. Therefore it is desirable to make $f_{\rm PFD}$ as large as possible or the R divider as small as possible but not smaller than 20.

The feedback ratio between the VCO output frequency and the PFD frequency shall be called N.

The following empirically derived formulas are rules of thumb for a phase margin of 56.4° and for receivers. ω_{U} shall be the unity gain bandwidth in rad/s of the open loop PLL transfer function.

$$\omega_U = \frac{2\pi f_C}{1.62} \tag{19}$$

$$a_0 = 3.3 \cdot \frac{I_{CP} \cdot K_{VCO}}{N \cdot \omega_U^2} \tag{20}$$

$$C_{F2} = \frac{a_0}{11} \tag{21}$$

$$C_{F1} = \frac{a_0 \cdot 10}{11} \tag{22}$$

$$R_F = \frac{3.63}{a_0 \cdot \omega_U} \tag{23}$$

The loop filter capacitors for 868 and 915MHz in the component list in section 6.3 are scaled down compared to the calculated values. Therefore the resistors have been scaled up by the same factor.



3.3 Receiver Front End

The radio frequency (RF) front-end of the receiver is a double-superheterodyne configuration that converts the input RF signal via a first intermediate frequency (IF1) signal to a second intermediate frequency (IF2) signal. While the range of IF1 can vary between 100 and 200MHz, IF2 is fixed to 2MHz. Both signals are completely processed internally. According to the block diagram (see Fig. 1), the front-end consists of an LNA, a first mixer (MIX1), a second mixer (MIX2), an internal IF filter (IFF) and an IF limiting amplifier (IFA) with received signal strength indicator (RSSI). The local oscillator signal for mixer 1 (LO1) is directly generated in the PLL frequency synthesizer. The LO2 signal for mixer 2 is derived from the LO1 signal via a divider (see 4.1.4).

There is no inherent suppression of the first mixer's image frequency. It depends on the particular application and the system's environmental conditions whether an RF front-end filter should be added or not. If image rejection and/or good blocking immunity are relevant system parameters, a band-pass filter must be placed either in front or after the LNA. This filter can be a SAW (surface acoustic wave) or LC-based filter (e.g. helical type). Because mixer 2 is an image rejection mixer, the image frequencies of the second mixing process are suppressed (see Fig. 2). The advantage of a two stage mixing receiver is the higher gain that can be achieved in the front end.

3.3.1 Low Noise Amplifier (LNA) and Mixer 1 (MIX1)

The LNA is based on a cascode topology for low-noise, high gain and good reverse isolation. The open collector output has to be connected to an external resonance circuit tuned to the receive frequency. The gain of the LNA can be changed to achieve a high dynamic range. There are four gain settings selectable by the control bits LNAGAIN (see 4.1.1). Default setting is the highest gain. The gain settings are automatically set if the automatic gain control (AGC) feature is activated (see 4.1.4).

The first mixer is a double-balanced mixer which converts the receive frequency to IF1. The default LO injection type for RF frequencies below 600MHz should be high side ($f_{LO1} = f_{RX} + f_{IF1}$). Low side injection ($f_{LO1} = f_{RX} - f_{IF1}$) is recommended for the higher frequency bands. Since the data polarity of an FSK modulated signal will be inverted by changing the injection side it is possible to change the data polarity at the data output (DTAO) via bit DTAPOL (see 4.1.1). Two gain settings of mixer 1 can be selected through MIX1GAIN (see 4.1.1): 14dB as a default value or 0dB optionally.

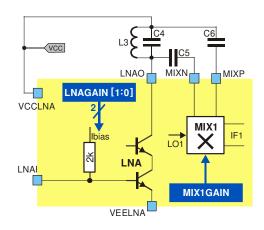


Fig. 11: LNA and Mixer 1

3.3.2 Mixer 2 (MIX2)

The second mixer is a double-balanced image rejection mixer in Hartley architecture using a complex poly-phase filter that converts the IF1 to the IF2 signal. The default LO injection type is low side ($f_{LO2} = f_{IF1} - f_{IF2}$), but also high side injection is possible ($f_{LO2} = f_{IF1} + f_{IF2}$), by setting SSBSEL to LOW (see 4.1.1). As for mixer 1, the injection side determines the polarity of the output signal. Two gain settings of mixer 2 can be selected by MIX2GAIN (see 4.1.1), a setting at 9dB (default) and one at -2dB.

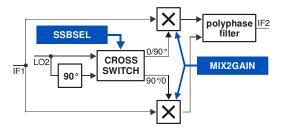


Fig. 12: Mixer 2 (Image Rejection Mixer)

3.3.3 IF Filter (IFF)

The MLX71122 comprises an internal IF filter with a -3dB bandwidth of 220kHz and a -40dB attenuation bandwidth of 1.6MHz. The filter contains three capacitively coupled bi-quad stages that represent resonant tanks close to the filter center frequency of 2MHz. The filter prototype is given in Fig.13. There exists an approximation formula to calculate the elements Ccx and Ctx when the center frequency, the -3dB bandwidth, the impedance level R and the inductivity L are given. The Ccx to Ctx ratio scales with the Q-factor of the bandpass filter. As a consequence of this the shape of the filter doesn't change in the Bode-plot if L is increased or decreased. This means the filter should always have about the same bandwidth if it is tuned to a certain center frequency.

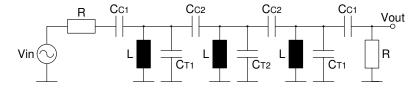


Fig. 13: IF filter prototype

Each LC-tank is realized as a bi-quad stage using transconductance cells that can be tuned by changing the bias current. This allows tuning of the center frequency. The bandwidth is related to the center frequency by the ratio of the coupling and the tank capacitors. Accuracy of the bandwidth relies on matching of the capacitors. The internal control word in IFFVAL (see 4.1.8) determines the current consumption of the filter and therefore of the whole receiver. Higher values lead to higher current consumptions. The deviation from the nominal current consumption can be about ±0.75mA. Four gain settings of the IF filter are selectable via IFFGAIN in register R0 (see 4.1.1). The default value is 0dB, other options are -14dB, -6dB and +6dB. It is recommended to leave the value at 0dB.

3.3.4 FSK Demodulator

FSK reception is turned on if bit MODSEL in register R5 is set to LOW (default). The demodulator is completely internally implemented, so no external, expensive discriminator device is needed. The used FSK demodulator is based on a phase shifter and a mixer as depicted in Fig.14.

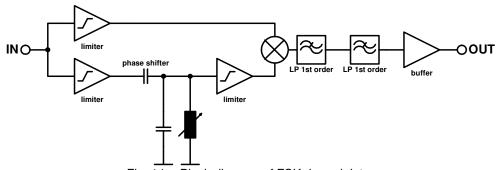


Fig. 14: Block diagram of FSK demodulator

The phase shifter provides a phase shift of 90 degrees to the original IF signal at exactly 2MHz. There is no AFC feature integrated since the frequency acceptance range of the demodulator is wide enough with about ±150kHz. The phase shift is regulated by the same control loop that controls the center frequency of the IF-filter. Tuning of the IF-filter will also change the DC value of the demodulator output. We recommend turning off the tuning during receive mode using IFFHLT (see 4.1.7) if small frequency deviations below ±20kHz have to be detected. The gain of the demodulator can be changed with bit DEMGAIN (see 4.1.1). It can be set to 12mV/kHz (default) or to 14.5mV/kHz.



3.3.5 Autotuning Circuit

An auto-tuning mechanism is implemented that permanently adjusts the bias current of the transconductance cells of the IF filter and the FSK demodulator in order to eliminate process, temperature and supply voltage variations. For this purpose a matched master bi-quad is used as oscillator in a current controlled oscillator (CCO) at 3MHz embedded in a PLL structure. A more detailed view on the tuning circuit is shown in Fig.15.

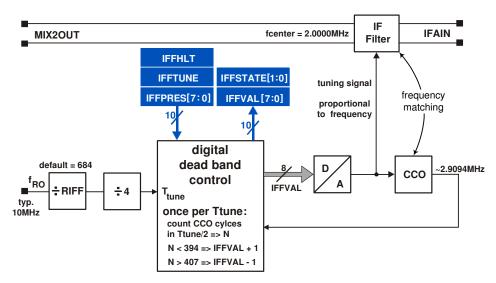


Fig.15: block diagram of digital tuning circuitry

The inputs are the RO frequency, output of the 2nd mixer, two register words (IFFPRES and RIFF, see 4.1.6 and 4.1.7) and 2 register bits (IFFHLT and IFFTUNE, see 4.1.7). The tuning circuit is working when IFFTUNE is HIGH and IFFHLT is LOW. If IFFHLT is HIGH then the digital tuning value IFFVAL remains at the last value. At falling transitions of IFFTUNE the preset value IFFPRES is loaded into the internal IFFVAL register and the tuning stops as well. IFFVAL and IFFSTATE (see 4.1.8) can be read out from register 7 if the MFO pin is programmed as SPI output (see 4.1.4). IFFSTATE shows the last action of the tuning circuit. It can show if the last value was increased, decreased or kept. A fourth state is indicating that the CCO is not running because of IFFHLT/IFFTUNE or a defect. It is possible to route the CCO output signal to the MFO pin for test purposes and to determining the ratio of the CCO and the filter.

The working principle of the digital tuning circuit is as follows. First the crystal frequency is divided by RIFF and then by 4. This is the tuning period with which the IFFVAL values can be changed. Now the digital control counts the positive edges of the CCO output in half of the tuning period. The typical count value for perfect tuning should be 400. Since the CCO shows phase noise it is necessary to define a certain dead band in which no tuning takes place. The limits are hardwired in the control logic and can not be changed. The lower dead band limit is 394 and the upper limit is 407. If the counts of CCO are smaller or larger than these values then the circuit increases or decreases IFFVAL by one. There is no change of IFFVAL if the count is inside the dead band.

Unfortunately glitches produced in the digital tuning circuit cause IFFVAL to be decreased even in the dead band. The glitches appear randomly but about 10 to 20 within one second. This causes the filter to be pushed towards the lower dead band limit. Once it is reached, IFFVAL will be decreased by 1 for one tuning period and be immediately increased in the next tuning period since the CCO count is smaller than 394. If the FSK frequency deviation is smaller than 15kHz and the peak detectors are used, then we recommend to disable the tuning with IFFHLT=1 during the reception period.

For typical process parameters, at room temperature and for 5V supply voltage the following assumptions can be made. One LSB of IFFVAL will shift the filter frequency by about 10.2kHz. The demodulator gain at low gain setting is about 12mV/kHz (leading to 120mV pulses due to the glitches!), one LSB of RIFF will shift



27 to 930MHz FSK/FM/ASK Receiver

the filter frequency by about 3kHz (reciprocal to RIFF!), one LSB of the CCO count shifts the frequency error of the filter by about 5kHz. The temperature drift of the filter is about 0.47 IFFVAL steps per Kelvin so the drift of the filter is about 4.8kHz per Kelvin.

3.3.6 IF Amplifier (IFA)

After passing the IF filter the receiving signal is amplitude limited by means of a high gain limiting amplifier. Its small signal gain is about 68dB. A received signal strength indicator (RSSI) voltage is generated in the IF amplifier. It is available at pin RSSI. The voltage at this pin is proportional to the input level of the receiver (in dB scales). There are two sensitivity settings selectable with RSSIGAIN (see 4.1.2), one with about 39mV/dB and the default setting with about 51mV/dB. By using this RSSI output signal the incoming signal strength of different transmitters can be determined. The same RSSI signal is used for receiving ASK modulated signals if MODSEL (see 4.1.6) is HIGH.

The IFA generates two digital signals RSSIL and RSSIH that indicate the level range of the RSSI voltage. If the level is in the lower quarter of the RSSI voltage range then both signals are LOW. If it is in the upper quarter of the RSSI range then both signals are HIGH. In between, the RSSIL signal is HIGH and RSSIH is LOW. Both values can be read out from register R7 of the IC (see 4.1.8). These two signals are also used for the AGC feature.

3.3.7 Automatic Gain Control (AGC)

The Automatic Gain Control (AGC) can be activated in SPI mode with AGCEN (see 4.1.4). By default, it is turned off. It uses the RSSIH and RSSIL signals of the IF amplifier to determine whether the gain has to be increased or decreased. The gain will be decreased beginning with the gain of the last stage. The gain increase works vice versa. The AGC circuit controls the gain of the LNA, and of mixer 1 and mixer 2. To avoid rapid gain switching, caused by short signal strength fluctuations or during ASK reception, the gain control operates with a time delay that can be programmed via AGCDEL (see 4.1.4). The time delay also depends on the PFD frequency of the IF filter auto-tuning circuit. There is no delay by default. AGCMODE (see 4.1.5), a second setting, determines whether the delay is applied for gain increase and decrease or only for gain increase. By default, a delay for increase and decrease is used.



3.4 Data Path

The data path contains all circuitry that is used to process the baseband signal. The MLX71122 comprises a second order Sallen-Key lowpass filter, two peak detectors and an output comparator as digital signal output.

3.4.1 Data Filter (DF)

The receive part of the MLX71122 contains a 2nd order Sallen-Key low-pass filter that can be configured by connecting two external capacitors C8 and C9 to the IC (see sec. 6). This data filter removes high frequency components and noise from the demodulated signal that may otherwise lower the signal to noise ratio at the comparator input. The filter bandwidth has to be adjusted to the maximum data rate. A good choice for the -3dB bandwidth is 85% of the data rate for NRZ codes and 170% for bi-phase or Manchester codes.

A characteristic between Bessel and Butterworth is best used in the data filter.

Since the internal resistors of the filter are both $200k\Omega$ and the overall gain is set to unity we obtain the following table for the capacitor values:

Coding	C8	C9				
NRZ Code	1.47 · C9	640 pF data rate / kbps				
Bi-Phase Code	1.47 · C9	320 pF data rate / kbps				

C9 should be rounded (down preferred) to the closest E-series value. C8 should be calculated from the rounded value before rounding it (down preferred) to the closest E-series value.

Example: base band signal 4kbps, NRZ coding

$$C9 = \frac{640pF}{4[kbps]} = 160pF \qquad \text{in E-series} \Rightarrow C9 = 150pF \qquad (24)$$

$$C8 = 1.47 \cdot 150 pF = 220.5 pF$$
 in E-series $\Rightarrow C8 = 220 pF$ (25)

3.4.2 Averaging Data Slicer Mode

The averaging data slicer mode is the default setting for the data path of the MLX71122. Bit SLCSEL in register R0 (see 4.1.1) is LOW if it is active and switch SW2 connects the pin SLC with DFO via a $200k\Omega$ resistor (see Fig. 1). With an external capacitor C10 at pin SLC, a simple low pass filter is formed that generates the threshold voltage for the output comparator. The value of C10 depends on the length of the packet preamble, the coding and the data rate. The larger the C10 value the longer the time until valid output data can be received at pin DTAO.

Averaging data slicer mode can be used for bi-phase or Manchester encoded bit streams since the DC-content of these codes is almost zero. The RC-time constant of the slicer can be calculated using:

$$t_{SLC} = 200k\Omega \cdot C10 \tag{26}$$

We recommend that t_{SLC} is at least 25 times as long as the bit time of the equivalent NRZ signal.

Example: base band signal 4kbps, NRZ coding

$$C10 = \frac{25 \cdot 0.25 \text{ms}}{200 \text{k}\Omega} = 31.25 \text{nF} \qquad \text{in E-series} \implies C10 = 33 \text{nF}$$



3.4.3 Peak Detectors (PKDET)

Peak detector mode is recommended for fast acquisition of the received data and if NRZ code is used. We recommend turning off the IFF auto tuning after the PLL lock during FSK-reception in peak detector mode. The peak detectors can be activated by setting SLCSEL to HIGH in register R0 (see 4.1.1). This connects SLC (pin 32) with the resistive voltage divider between PDP (pin 25) and PDN (pin 26) (see Fig. 1). The peak detector at PDP is used to detect the maximum of the voltage at DFO and the peak detector at PDN detects the minimum of the voltage at DFO. Since the voltage divider is symmetric, the threshold voltage will be in the middle of the minimum and maximum voltages at DFO. The peak voltages are proportional to the charge that is stored on the peak detector capacitors at PDP (C11) and PDN (C12). All pull-up and pull-down currents are given in sec. 5.5. Because both pins are connected via a $2M\Omega$ resistor, both peak detector capacitors will be discharged with a time constant depending on the value of the capacitors. For equal values of both capacitors (C = C11 = C12), the time constant will be:

$$t_{\text{DIS}} = 2M\Omega \cdot 0.5 \cdot C \tag{27}$$

The minimum value of t_{DIS} is limited by the maximum number of equal consecutive bits. A value of t_{DIS} of at least 4 times the number of equal consecutive bits is a good choice.

Example: base band signal 4kbps, NRZ coding, max. 32 equal consecutive bits

$$C11 = C12 = \frac{32 \cdot 4 \cdot 0.25 ms}{0.5 \cdot 2M\Omega} = 32nF \qquad \text{in E-series} \Rightarrow C11 = C12 = 33nF$$

The maximum capacitor value may also be limited by the pull-up and pull-down currents of the peak detectors given in sec. 5.5, because C11 and C12 have to be charged during the first bits of the preamble of the data packet. The capacitors C11 and C12 are discharged if the circuit is powered but not in receive mode (see 3.8). The capacitor C11 will be pre-charged with ground potential and C12 will be pre-charged with VCC potential in order to prepare the peak data slicer circuit for fast output of valid data.

3.4.4 Output Comparator

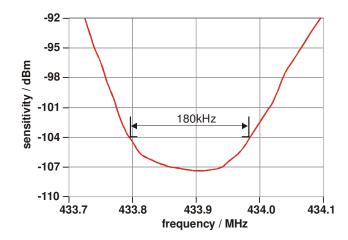
The output comparator or data slicer decides whether the incoming signal is a digital LOW or HIGH by using the reference voltage at SLC (pin 32). If the internal voltage is larger than the reference then the output is HIGH and vice versa. Nevertheless, the polarity of the output comparator can be inverted. The driving capability of the comparator output is $\pm 2mA$ and in standby mode the tri-state output is at high impedance. Pin DTAO must not be connected by a low impedance to a fixed voltage supply or a stronger driver output! We recommend using a series resistance of $10k\Omega$ to connect DTAO.

3.5 Frequency Acceptance Range

The frequency acceptance range is defined as the bandwidth where the input sensitivity can be degraded by 3dB at a maximum, compared to the sensitivity at the center frequency of the channel.

Typically, the frequency acceptance range of the MLX71122 is about 180kHz, see Fig. 16. The frequency acceptance range is mainly depending on the frequency deviation, and slightly on the modulation frequency. The larger the frequency deviation the smaller the acceptance range.

Fig. 16: Measured sensitivity characteristic (BER=3·10⁻³, 4kbps, Δf=±20kHz)





27 to 930MHz FSK/FM/ASK Receiver

3.6 Biasing System

The biasing system needs an external $30k\Omega$ resistor that is connected between RBIAS (pin 10) and the PCB ground. The band-gap voltage at RBIAS causes a reference current flow of about $42\mu\text{A}$ through this reference current resistor. The accuracy of the external resistor should be within $\pm 2\%$. To minimize the temperature dependency it is recommended to use a metal film resistor.

3.7 Operating Modes

The MLX71122 has four operating modes having an impact on the receiver's current consumption. The OPMODE bits in register R0 (see 4.1.1) determine the operating mode. Selections are:

00 – Shutdown
 01 – Receive
 all blocks deactivated, only SPI active (default)
 receiving data from LNAI at selected frequency

10 – RO and bias only only biasing system and reference oscillator are working

11 – Synthesizer only only biasing system, reference oscillator and PLL are working

The first operating mode consumes virtually no current. The circuit is dead except of the SPI that can listen to commands. In Receive mode all necessary blocks are turned on in order to receive data at the programmed frequency.

The last two operating modes can be used to accelerate the start-up time of the circuit after periods of silence. With RO and bias only, the start-up time of the reference oscillator (RO) can be circumvented. RO and biasing consume not as much current as the whole receiver. With Synthesizer only the full PLL is already working and locked. Current consuming blocks as the LNA, the IF-filter and the FSK-demodulator are turned off in this state. The last mode is useful if the receiver has to listen frequently.

3.8 Multi Functional Output

The Multi Functional Output (pin 23) can be used to read out the control register settings or to make other internal signals available at this pin. The output is controlled by the bits MFO in register R3 (see 4.1.4). The most important selections are:

•	0000 - Z-State	MFO pin is in high impedance mode
•	0001 - SPI-out	MFO pin is digital serial output for data of registers (default in SPI-mode)
•	0010 - Logic-0	MFO pin is pulled to ground
•	0011 – Logic-1	MFO pin is pulled to VCC
•	0100 - RO-out	MFO pin is buffered, analogue output of RO frequency (default in ABC-mode)
•	0101 – IF-out	MFO pin is buffered, analogue output of IF2 signal after the IF-filter
•	1000 – LD-out	MFO pin represents lock state of PLL
•	1011 - CCO-out	MFO pin represents CCO output

Z-State, Logic-0 and Logic-1 can be used to provide digital control signals to other circuits on the PCB. In state RO-out a 10MHz clock frequency is available at MFO, e.g. for driving a microcontroller. At IF-out pin MFO provides the IFF output, amplified by a factor of 5 (unloaded). In this case the output resistance is about 610Ω . The IF-out mode can be used for checking the IFF characteristics or for further signal processing, e.g. to add an external limiting amplifier and demodulator. With the LD-out setting the state of the PLL can be read out. All other selections are for test purposes. The CCO-out option can be used to check the ratio between the internal CCO and the IF filter frequency.

27 to 930MHz FSK/FM/ASK Receiver

3.9 SPI Description

3.9.1 General

Serial programming interface (SPI) mode can be activated by choosing SPISEL = 1 (e.g. at positive supply voltage V_{CC}). In this mode, the input pins 17, 18 and 19 are used as a 3-wire unidirectional serial bus interface (SDEN, SDTA, SCLK). The internal latches contain all user programmable variables including counter settings, mode bits etc.

In addition the MFO pin can be programmed as an output (see section 4.1.4) in order to read data from the internal latches and it can be used as an output for different test modes as well.

At each rising edge of the SCLK signal, the logic value at the SDTA terminal is written into a shift register. The programming information is taken over into internal latches with the rising edge of SDEN. Additional leading bits are ignored, only the last bits are serially clocked into the shift register. A normal write operation shifts 16 bits into the SPI, a normal read operation shifts 4 bits into the SPI and reads additional 12 bits from the MFO pin. If less than 12 data bits are shifted into SDTA during the write operation then the control register may contain invalid information.

In general a control word has the following format. Bit 0 is the Read/Write bit that determines whether it is a read (R/W = 1) or a write (R/W = 0) sequence. The R/W bit is preceding the latch address and the corresponding data bits.

Control Word Format															
MSB											LSB	MSB		LSB	Bit 0
Data										Latch Address Mod			Mode		
D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	A2	A2	A0	R/W

There are two control word formats for read and for write operation. Data bits are only needed in write mode. Read operations require only a latch address and a R/W bit.

Due to the static CMOS design, the serial interface consumes virtually no current. The SPI is a fully separate building block and can therefore be programmed in every operational mode.



3.9.2 Read / Write Sequences

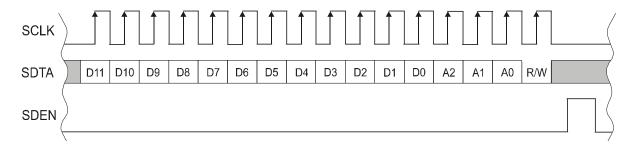


Fig. 17 Typical write sequence diagram

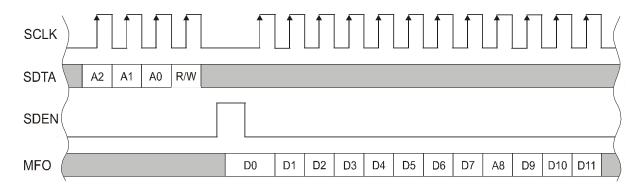


Fig. 18 Typical read sequence diagram

3.9.3 Serial Programming Interface Timing

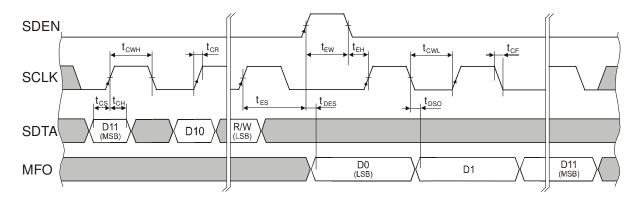


Fig. 19 SPI timing diagram



4 Register Description

The following tables are to describe the functionality of the registers.

Sec. 4.1 provides a register overview with all the control words R0 to R7. The subsequent sections. 4.1.1 to 4.1.8 show the content of the control words in more detail.

Programming the registers requires SPI mode (SPISEL = 1). Default settings are for ABC mode.

4.1 Register Overview

CONTROL WORD	MSB LSB										LATCH ADDRESS				
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	0	0	0	0	1	0	0	0	1	1	0	0	0	0	0
R0	DTAPOL	SLCSEL SSBSEL DEMGAIN			IFFGAIN [1:0]		MIX2GAIN	MIX1GAIN	LNAGAIN [1:0]		OPMODE [1:0]		read/ write		
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	1	0	0	0	1	1	1	1	0	1	0	0	0	0	1
R1	SHOWLD	PRESCUR VCOBUF VCOCUR			VCORANGE	RSSIGAIN	LDTIME	[1:0]	LDERR PFDPOL		CPCUR [1:0]		read/ write		
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	1	1	1	1	0	0	0	1	0	1	0	0	0	1	0
R2	N [6:0]							A [4:0]					read/ write		
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	0	0	0	1	0	0	0	0	0	0	0	0	0	1	1
R3	MFO [3:0]				AGCDEL	[1:0]	AGCEN	LO2DIV N [110:7]				read/ write			



27 to 930MHz FSK/FM/ASK Receiver

CONTROL						DA	TA					_		ATC	
WORD	MSB											LSB	AD	DRE	SS
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	0	0	0	0	0	1	0	0	1	0	1	1	1	0	0
R4	AGCMODE						R [10:0]							read/ write	
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	0	0	1	0	1	0	1	0	1	1	0	0	1	0	1
R5	MODSEL						RIFF [10:0]							read/ write	
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default	1	1	1	0	1	0	0	0	0	1	0	1	1	1	0
R6	ROCUR	[1 :0]	IFFTUNE	IFFHLT				IFFPRES	[7:0]					read/ write	
Bit No.	11	10	9	8	7	6	5	4	3	2	1	0	MSB		LSB
default													1	1	1
R7	RSSIH	LDRSSIL*	IFFSTATE	[1:0]				IFFVAL	[7:0]					read- only	

Note: * depends on bit 11 in R4, 0 = RSSIL, 1 = LD

27 to 930MHz FSK/FM/ASK Receiver

4.1.1 Control Word R0

Name	Bits	_		Description		
				operation mode		
OPMODE	[1:0]	00 01 10 11	shutdown receive mode reference oscillato synthesizer only	or & BIAS only	#default	
				LNA gain		
LNAGAIN	[3:2]	00 01 10 11	lowest gain low gain high gain highest gain	(default – 20dB) (default – 6dB) (default – 2dB) (default – 0dB)	#default	
			gain values are relative			
MIX1GAIN	[4]		T	1 st Mixer gain	<i>u</i> 1 <i>c</i> 1	
MIXIGAIN	[4]	0 1	high gain low gain	(14dB) (0dB)	#default	
				2 nd Mixer gain		
MIX2GAIN	[5]	0 1	high gain low gain	(9dB) (-2dB)	#default	
			inte	rmediate frequency filter gain		
IFFGAIN	[7:6]	00 01 10 11	lowest gain low gain high gain highest gain	(-14dB) (-6dB) (0dB) (+6dB)	#default	
				demodulator gain		
DEMGAIN	[8]	0 1	low gain high gain	(~ 12mV/kHz) (~ 14.5mV/kHz)	#default	
			;	single side band selection		
SSBSEL	[9]	0 1	upper side band lower side band	LO2 low-side inj. (IF1 = LO2 + IF2) LO2 high-side inj. (IF1 = LO2 - IF2)	#default	
			Internal IF2 = 2MHz			
				slicer mode select		
SLCSEL	[10]	0 1	averaging Data Slicer mode #det peak detector Data Slicer mode			
				data output polarity OA2		
		0	inverted		#default	
DTAPOL	[11]		'1' for space at ASK or f			
		1	normal			
			'0' for space at ASK or f	min at FSK, '1' for mark at ASK or f _{max} at FSK		

27 to 930MHz FSK/FM/ASK Receiver

4.1.2 Control Word R1

Name	Bits		Description			
			charge pump current setting			
CPCUR	[1:0]	00 01 10 11	100μA 400μA 400μA static down 400μA static up	#default		
			PFD output polarity			
PFDPOL	[2]	0 1	negative positive	#default		
	101		lock detector time error			
LDERR	[3]	0 1	15ns 30ns	#default		
			lock detection time			
LDTIME	[5:4]	00 01 10 11	2/f _R 4/f _R 8/f _R 16/f _R minimum time span before lock in	#default		
			f_R is the reference oscillator frequency f_{RO} divided by R, see section 4.1.5	5 (R4)		
RSSIGAIN	[6]		sensitivity of RSSI voltage			
HOSIGAIN	[0]	0 1	low gain (~39mV/dB) high gain (~51mV/dB)	#default		
			VCO range			
VCORANGE	[7]	0	3V supply 5V supply	#default		
			VCO range setting for different VCCs.			
VCOCUR	[0]		VCO core current	// -l - f lı		
VCOCOR	[8]	0	450μA 520μA	#default		
			VCO buffer current			
VCOBUF	[9]	0 1	900μA 1040μA	#default		
			prescaler 32/33 reference current			
PRESCUR	[10]	0	20μA 30μA	#default		
			30μA may be used for f _{RF} = 868/915MHz			
			function of LDRSSIL bit			
SHOWLD	[11]	0 1	RSSIL (RSSI low flag) LD (lock detection flag)	#default		
			select output data of LDRSSIL, see section 4.1.8 (R7)			

27 to 930MHz FSK/FM/ASK Receiver

4.1.3 Control Word R2

Name	Bits		Description					
			swallow counter value					
Α	[4:0]	10100	value is 20	#default				
			swallow counter range: 0 to 31					
			program counter value (bits 0 - 6)					
N	[11:5]	000 0111 1000	N value is 120	#default				
			N counter range: 3 to 2047					

4.1.4 Control Word R3

				program counter range (bits 7 – 10)	
N	[3:0]	000 0111 1000		N value is 120	#default
				N counter range: 3 to 2047	
				LO2 divider ratio	
LO2DIV	[4]	0	divide b		#default
		1	divide b	-	
ACCEN	[[]	_		AGC enable mode	
AGCEN	[5]	0	disabled		#default
		I.	enabled	AGC delay settings	
		00	no dolos	, ,	#default
	r= 01	00 01	no delay		#uerauit
AGCDEL	[7:6]	10	15/f _{IFF}		
		11	31/f _{IFF}		
			f _{IFF} is the r	reference oscillator frequency $f_{\text{RO}}\text{divided}$ by RIFF, see section 4.	1.6 (R6)
				multi functional output	
		0000	Z state		
		0001	SPI read		#default
		0010 0011	MFO = 0 MFO = 1		
		0100		RO output	
		0101		FF output	
		0110		(for test purposes)	
MFO	[11:8]	0111		(for test purposes)	
		1000		ect output	
		1001		er output (for test purposes)	
		1010 1011		er output (for test purposes)	
		1100		tput (for test purposes) er MC bit output with SCLK as clock (for test)	
		1101		er output with SCLK as clock (for test)	
		1110		er output with SCLK as clock (for test)	
		1111	RIFF ou	tput with SCLK as clock (for test)	

27 to 930MHz FSK/FM/ASK Receiver

4.1.5 Control Word R4

Name	Bits		Description			
			reference divider range			
R	[10:0]	000 01	100 1011	value is 75	#default	
				R counter range: 3 to 2047		
				AGC delay mode		
AGCMODE [11]		0	 gain decrease and increase with delay gain decrease without delay, gain increase with delay 			
			selects AG	C delay mode in combination with AGCDEL bits, see section 4.1	.4 (R3)	

4.1.6 Control Word R5

Name	Bits		Description					
			reference divider value for IFF adjustment					
RIFF	[10:0]	010 10	010 1100	value is 684	#default			
				IFF counter range: 4 to 2047				
			demodulation selection					
MODSEL	[11]	0		modulation modulation	#default			
			selects mo	dulation type when chip is controlled via SPI mode				

4.1.7 Control Word R6

Name	Bits		Description			
				IFF preset value		
IFFPRES	[7:0]	010	1 1011	value is 91	#default	
				IFF DAC preset at start of automatic tuning		
				IFF halt		
IFFHLT	[8]	0 1				
			suspends	IFF automatic tuning		
				IFF tuning		
IFFTUNE	[9]	0	disable enable	and load DAC with IFFPRES	#default	
				reference Oscillator core current		
ROCUR	[11:10]	00 01 10 11	85μΑ 170μΑ 270μΑ 355μΑ		#default	



27 to 930MHz FSK/FM/ASK Receiver

4.1.8 Control Word R7 (Read-only Register)

Name	Bits	Description				
		IFF adjustment value				
IFFVAL	[7:0]					
		see also IFFPRES in section 4.1.7 (R6)				
		IFF automatic tuning state				
IFFSTATE	[9:8]	00 filter tuned or auto-tuning disabled 01 tuning up the filter frequency 10 tuning down the filter frequency 11 master oscillator of filter does not work				
		lock detector or RSSI low flag				
LDRSSIL	[10]	[10]	[10]	[10]	0 PLL not locked or RSSI value in lower region 1 PLL locked or RSSI value above lower region	
		depends on SHOWLD in section 4.1.2 (R1)				
		RSSI high flag				
RSSIH [11]		0 RSSI value below upper region 1 RSSI value in upper region				



5 Technical Data

5.1 Absolute Maximum Ratings

Operation beyond absolute maximum ratings may cause permanent damage of the device.

Parameter	Symbol	Condition / Note	Min	Max	Unit
Supply voltage	V_{CC}		0	7.0	V
Input voltage	V _{IN}		- 0.3	V _{cc} +0.3	V
Input RF level	P_{iRF}	@ LNA input		10	dBm
Storage temperature	T _{STG}		-55	+125	$_{\circ}$
Junction temperature	T _J			+150	$_{\mathbb{C}}$
Thermal Resistance	R_{thJA}			60	K/W
Power dissipation	P _{diss}			0.1	W
Electrostatic discharge	V _{ESD1}	human body model, 1)	-1.0	+1.0	kV.
	V _{ESD2}	human body model, 2)	-0.75	+0.75	kV

¹⁾ all pins except LNAO

5.2 Normal Operating Conditions

Parameter	Symbol	Condition	Min	Max	Unit
Supply voltage	V_{CC}		3.0	5.5	V
Operating temperature	T _A		-40	+110	ōC
Input low voltage (CMOS)	V _{IL}	ENRX, SEL pins, A/SCLK B/SDTA, C/SDEN		0.3 · V _{CC}	٧
Input high voltage (CMOS)	V _{IH}	ENRX, SEL pins, A/SCLK B/SDTA, C/SDEN	0.7 · V _{CC}		V
Input frequency range	f_{RF}	3)	27	930	MHz
IF1 range	f _{IF1}	4)	6	190	MHz
IF2	f _{IF2}			2	MHz
XOSC frequency	f _{ref}	set by the crystal		10	MHz
VCO frequency	f_{LO}	5)	33	750	MHz
Frequency offset of carrier	f _{CAR}		-100	100	kHz
Frequency deviation	Δf		±10	±50	kHz
FSK data rate	R_{FSK}	NRZ		100	kbps
ASK data rate	R _{ASK}	NRZ		100	kbps
FM bandwidth	f _m			15	kHz

³⁾ production tested down to 300MHz, 27MHz proven by application at 5V supply and room temperature

²⁾ pin LNAO

⁴⁾ production tested down to 80MHz, 6MHz proven by application at 5V supply and room temperature

⁵⁾ production tested down to 400MHz, 33MHz proven by application at 5V supply and room temperature



5.3 Crystal Parameters

Parameter	Symbol	Condition	Min	Max	Unit
Crystal frequency	f_0	fundamental mode, AT		10	MHz
Load capacitance	CL		10	15	pF
Static capacitance	Co			7	pF
Series resistance	R ₁			70	Ω

5.4 Serial Programming Interface (SPI)

Parameter	Symbol	Condition	Min	Max	Unit
Input High Voltage	V _{IH}		$V_{CC} - 0.4$		V
Input Low Voltage	V _{IL}			0.4	V
SLCK frequency	f _{SLCK}			10	MHz
SLCK period	t _{SLCK}		100		ns
SDTA to SCLK set up time	t _{CS}		20		ns
SCLK to SDTA hold time	t _{CH}		20		ns
SCLK pulse width low	t _{CWL}		50		ns
SCLK pulse width high	t _{CWH}		50		ns
SCLK to SDEN set up time	t _{ES}		30		ns
SDEN pulse width	t _{EW}		50		ns
SDEN to SCLK hold time	I		20		ns
Rising Edge of SLCK	t _{CR}			0.1 t _{SLCK}	ns
Falling Edge of SLCK	t _{CF}			0.1 t _{SLCK}	ns
SDEN to MFO data set-up time	t _{DES}			70	ns
SCLK to MFO data set-up time	t _{DSO}			50	ns
MFO max. pin load capacitance	C _{LMFO}	-		20	pF

27 to 930MHz FSK/FM/ASK Receiver

DC Characteristics 5.5

- all parameters under normal operating conditions and default settings, unless otherwise stated typical values at T_A = 23 $^{\circ}$ C and V_{CC} = 5 V
- all parameters based on test circuits as shown in Fig. 20 to Fig. 22

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Operating Currents						
Shutdown current	I _{SBY}	OPMODE=00 and ENRX=0		50	500	nA
Supply current, FSK	I _{FSK}	OPMODE=01 or ENRX=1	10	12	15	mA
Supply current, ASK	I _{ASK}	OPMODE=01 or ENRX=1	9.5	11.5	14.5	mA
Supply current, RO only	I _{RO}	OPMODE=10 and ENRX=0	0.4	0.8	1.2	mA
Supply current, Synthesizer only	I _{SYN}	OPMODE=11 and ENRX=0	3	4	5	mA
Digital Pin Characteristics						
Input low voltage CMOS, ENRX	V_{ILEN}	ENRX pin	-0.3		0.3 · V _{cc}	V
Input high voltage CMOS, ENRX	V_{IHEN}	ENRX pin	0.7 · V _{CC}		V _{CC} +0.3	V
Pull down current ENRX pin	I _{PDEN}	ENRX=1	1.5	5	8	μΑ
Low level input current ENRX pin	I _{INLEN}	ENRX=0			0.05	μΑ
Input low voltage CMOS	V_{IL}	Pins MODSEL, SPISEL, A/SCLK, B/SDTA, C/SDEN	-0.3		0.3 · V _{cc}	V
Input high voltage CMOS	V _{IH}	Pins MODSEL, SPISEL, A/SCLK, B/SDTA, C/SDEN	0.7 · V _{CC}		V _{CC} +0.3	V
Low level input leakage current	I _{IL}	Pins MODSEL, SPISEL, A/SCLK, B/SDTA, C/SDEN	-2			μΑ
High level input leakage current	I _{HL}	Pins MODSEL, SPISEL, A/SCLK, B/SDTA, C/SDEN			2	μА
Analog Pin Characteristics						
OA1 input offset voltage	V_{OFFOA1}	OA1	-50		50	mV
OA2 input offset voltage	V_{OFFOA2}	OA2	-20		20	mV
OA2 current sinking capability	I _{OA2SINK}	OA2 (DTAO pin)			2	mA
OA2 current sourcing capability	I _{OA2SRC}	OA2 (DTAO pin)			2	mA
Peak detector P pull-up current	I _{PDPPU}	PDP		235		μΑ
Peak detector N pull-down current	I _{PDNPD}	PDN		270		μΑ

27 to 930MHz FSK/FM/ASK Receiver

AC System Characteristics

- all parameters under normal operating conditions and default settings, unless otherwise stated typical values at T_A = 23 °C and V_{CC} = 5 V, RF at 433.92 MHz all parameters based on test circuits as shown in Fig. 20 to Fig. 22

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Receive Characteristics	<u> </u>				<u> </u>	
Input sensitivity – FSK (standard)	P _{min, FSK}	$\Delta f = \pm 20 \text{kHz},$ 4kbps NRZ, BER $\leq 3.10^{-3}$		-107		dBm
Input sensitivity – FSK (with carrier offset)	P _{min, FSK,} offs	$\Delta f = \pm 20 \text{kHz},$ 4kbps NRZ, $\pm 90 \text{kHz}$ carrier offset BER $\leq 3.10^{-3}$		-104		dBm
Input sensitivity – ASK	P _{min, ASK}	100% on-off ratio 4kbps NRZ, BER ≤ 3·10 ⁻³		-112		dBm
Maximum input signal – FSK/FM	$P_{\text{max, FSK}}$	BER ≤ 3·10 ⁻³		0		dBm
Maximum input signal – ASK	P _{max, ASK}	BER ≤ 3·10 ⁻³		-10		dBm
Spurious emission	P _{spur}				-54	dBm
Image rejection of MIX2	ΔP_{imag}			32		dB
IF Filter Parameters						
Center frequency	f _{IF}	static with tuning on	1.87	2.00	2.04	MHz
3dB bandwidth	B _{3dB}		180	220	260	kHz
40dB bandwidth	B _{40dB}			1.6		MHz
RSSI Characteristics						
Low voltage	V_{LRSSI}	high gain			0.75	V
High voltage	V _{HRSSI}	high gain	2.65			V
RSSI dynamic range	DR _{RSSI}			50		dB
RSSI sensitivity, low gain	S _{RSSIL}	low gain		39		mV/dB
RSSI sensitivity, high gain	S _{RSSIH}	high gain		51		mV/dB
FSK Demodulator						
Demodulator gain, low	DG _{LOW}			12		mV/
Demodulator gain, high	DG _{HIGH}			14.5		kHz
Maximum data rate	B _{DEM}	NRZ			100	kbps
Frequency acceptance range	BW_{DEMOD}	$\Delta f = \pm 20kHz$	150			kHz
Start-up Parameters						
Crystal start-up time	T _{XTL}			0.9		ms
Receiver start-up time	T _{RX}	depends on data slicer; valid data at output			T _{XTL} + 200k · C10	
PLL lock time	T_PLL	from OPMODE=10		0.4		ms
PLL Parameters						
VCO gain @ 433MHz	K _{VCO}	for VCORANGE=1		85		MHz/V
VCO gain @ 868MHz	K _{VCO}	for VCORANGE=1		108		MHz/V
Charge pump current	I _{CP}	depends on CPCUR	100		400	μΑ



6 Test Circuits

6.1 Standard FSK & ASK Reception in 8-Channel Preconfigured (ABC) Mode

6.1.1 Averaging Data Slicer for Bi-Phase Codes (e.g. Manchester)

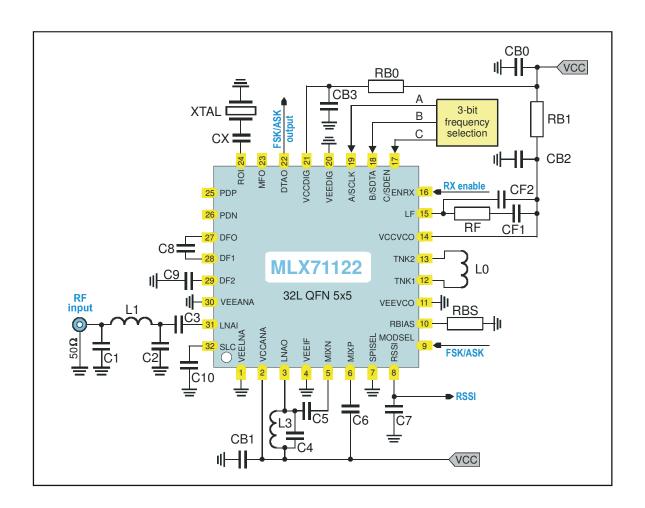


Fig. 20: Test circuit for FSK & ASK reception



6.2 Standard FSK & ASK Reception in SPI Mode

6.2.1 Averaging Data Slicer for Bi-Phase Codes (e.g. Manchester)

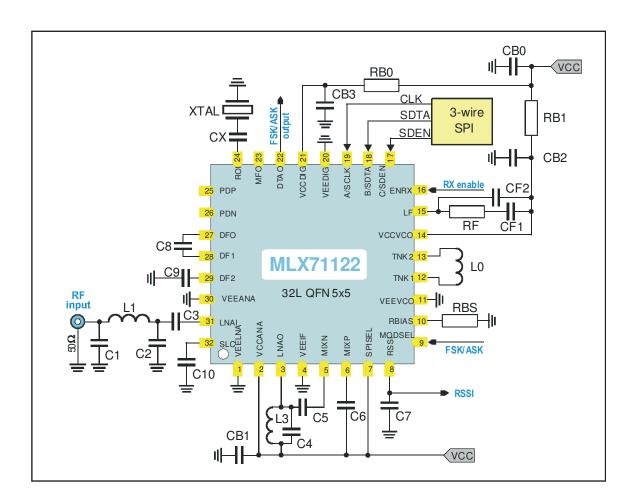


Fig. 21: Test circuit for FSK & ASK reception



6.2.2 Peak Detector Data Slicer Configured for NRZ Codes

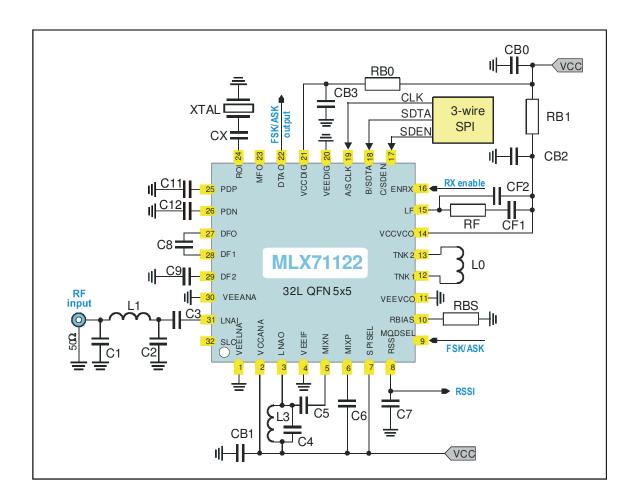


Fig. 22: Test circuit for FSK & ASK reception

27 to 930MHz FSK/FM/ASK Receiver

6.3 Test Circuit Component List

Below table shows components for all test circuits of Figures 20 to 22.

Part	Size	Value @ 27 MHz	Value @ 315 MHz	Value @ 433.92 MHz	Value @ 868.3 MHz	Value @ 915 MHz	Tol.	Description
C1	0603	150 pF	3.9 pF	4.7 pF	3.3 pF	1.5 pF	±5%	matching capacitor
C2	0603	39 pF	1.5 pF	1.5 pF	1.5 pF	1.5 pF	±5%	matching capacitor
C3	0603	1 nF	100 pF	100 pF	100 pF	100 pF	±5%	LNA input filtering capacitor
C4	0603	22 pF	4.7 pF	3.3 pF	2.7 pF	2.2 pF	±5%	LNA output tank capacitor
C5	0603	100 pF	100 pF	100 pF	100 pF	100 pF	±5%	MIX1 negative input matching capacitor
C6	0603	100 pF	100 pF	100 pF	100 pF	100 pF	±5%	MIX1 negative input matching capacitor
C7	0603	1 nF	1 nF	1 nF	1 nF	1 nF	±10%	RSSI output low pass capacitor, for data rate of 4 kbps NRZ
C8	0603	220 pF	220 pF	220 pF	220 pF	220 pF	±10%	data low-pass filter capacitor, for data rate of 4 kbps NRZ
C9	0603	150 pF	150 pF	150 pF	150 pF	150 pF	±10%	data low-pass filter capacitor, for data rate of 4 kbps NRZ
C10	0603	33 nF	33 nF	33 nF	33 nF	33 nF	±10%	data slicer capacitor,
010	0000			required in Fig			±1076	for data rate of 4 kbps NRZ
C11	0603	33 nF	33 nF	33 nF	33 nF	33 nF	±10%	PKDET positive filtering capacitor, for
_				ired in Figs. 20				data rate of 4 kbps NRZ
C12	0603	33 nF	33 nF	33 nF	33 nF	33 nF	±10%	PKDET negative filtering capacitor, for data rate of 4 kbps NRZ
			not requ	ired in Figs. 20	and 21			· ·
СВО	1210	220 nF	220 nF	220 nF	220 nF	220 nF	±10%	decoupling capacitor, low-noise power supply recommended
CB1	0603	10nF	470 pF	470 pF	470 pF	470 pF	±10%	decoupling capacitor
CB2	0603	10 μF	10 μF	10 μF	10 μF F	10 μF	±10%	decoupling capacitor
CB3	0603	33 nF	33 nF	33 nF	33 nF	33 nF	±10%	decoupling capacitor
CF1	0603	1 μF	2.2 nF	2.2 nF	2.2 nF	2.2 nF	±5%	loop filter capacitor
CF2	0603	100 nF	220 pF	220 pF	220 pF	220 pF	±5%	loop filter capacitor
CX	0603	27 pF	27 pF	27 pF	27 pF	27 pF	±5%	crystal series capacitor
RB0	0603	10 Ω	10 Ω	10 Ω	10 Ω	10 Ω	±5%	protection resistor
RB1	0603	270 Ω	270 Ω	270 Ω	270 Ω	270 Ω	±5%	protection resistor
RF	0603	1k Ω	27 kΩ	27 kΩ	47 kΩ	47 kΩ	±5%	loop filter resistor
RBS	0603	30 kΩ	30 kΩ	30 kΩ	30 kΩ	30 kΩ	±2%	reference bias resistor
L0	0603	3.3 μΗ	33 nH	15 nH	8.2 nH	8.2 nH	±5%	VCO tank inductor
L1	0603	1 μΗ	68 nH	47 nH	22 nH	15 nH	±5%	matching inductor
L3	0603	1.5 μΗ	33 nH	22 nH	5.6 nH	5.6 nH	±5%	LNA output tank inductor
XTAL	SMD 5x3.2		±2	10.00000 20ppm cal., ±3				fundamental-mode crystal

Remarks:

27 MHz	315 MHz	433.92 MHz	868.3 MHz	915 MHz	Description
750	75	75	125	125	reference divider value R
13 kHz	133 kHz	133 kHz	80 kHz	80 kHz	PFD frequency f _{PFD}
10 kHz	100 kHz	100 kHz	100 kHz	100 kHz	frequency step size



7 Package Description



The device MLX71122 is RoHS compliant.

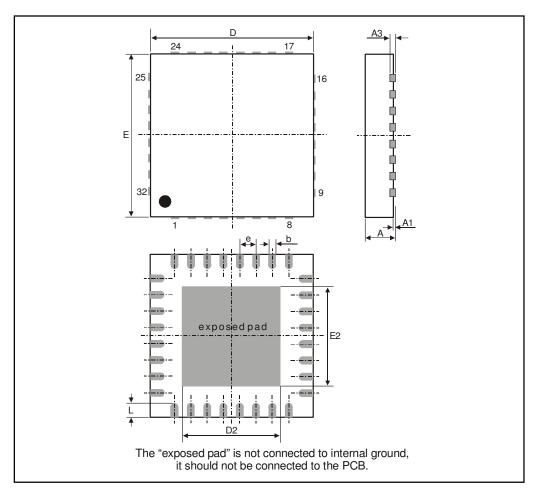


Fig. 23: 32L QFN 5x5 Quad

all Dime	all Dimension in mm											
	D	Е	D2	E2	Α	A1	А3	L	е	b		
min	4.75	4.75	3.00	3.00	0.80	0	0.20	0.3	0.50	0.18		
max	5.25	5.25	3.25	3.25	1.00	0.05	0.20	0.5	0.30	0.30		
all Dime	all Dimension in inch											
min	0.187	0.187	0.118	0.118	0.0315	0	0.0079	0.0118	0.0107	0.0071		
max	0.207	0.207	0.128	0.128	0.0393	0.002	0.0079	0.0197	0.0197	0.0118		

7.1 Soldering Information

 The device MLX71122 is qualified for MSL3 with soldering peak temperature 260 deg C according to JEDEC J-STD-20



MLX71122 27 to 930MHz FSK/FM/ASK Receiver

8 Standard information regarding manufacturability of Melexis products with different soldering processes

Our products are classified and qualified regarding soldering technology, solderability and moisture sensitivity level according to following test methods:

Reflow Soldering SMD's (Surface Mount Devices)

- IPC/JEDEC J-STD-020
 Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices (classification reflow profiles according to table 5-2)
- EIA/JEDEC JESD22-A113
 Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing (reflow profiles according to table 2)

Wave Soldering SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

- EN60749-20
 Resistance of plastic- encapsulated SMD's to combined effect of moisture and soldering heat
- EIA/JEDEC JESD22-B106 and EN60749-15
 Resistance to soldering temperature for through-hole mounted devices

Iron Soldering THD's (Through Hole Devices)

EN60749-15
 Resistance to soldering temperature for through-hole mounted devices

Solderability SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

 EIA/JEDEC JESD22-B102 and EN60749-21 Solderability

For all soldering technologies deviating from above mentioned standard conditions (regarding peak temperature, temperature gradient, temperature profile etc) additional classification and qualification tests have to be agreed upon with Melexis.

The application of Wave Soldering for SMD's is allowed only after consulting Melexis regarding assurance of adhesive strength between device and board.

Melexis is contributing to global environmental conservation by promoting **lead free** solutions. For more information on qualifications of **RoHS** compliant products (RoHS = European directive on the Restriction Of the use of certain Hazardous Substances) please visit the quality page on our website: http://www.melexis.com/quality.aspx

9 ESD Precautions

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD). Always observe Electro Static Discharge control procedures whenever handling semiconductor products.



27 to 930MHz FSK/FM/ASK Receiver

Notes



27 to 930MHz FSK/FM/ASK Receiver

10 Disclaimer

Devices sold by Melexis are covered by the warranty and patent indemnification provisions appearing in its Term of Sale. Melexis makes no warranty, express, statutory, implied, or by description regarding the information set forth herein or regarding the freedom of the described devices from patent infringement. Melexis reserves the right to change specifications and prices at any time and without notice. Therefore, prior to designing this product into a system, it is necessary to check with Melexis for current information. This product is intended for use in normal commercial applications. Applications requiring extended temperature range, unusual environmental requirements, or high reliability applications, such as military, medical life-support or life-sustaining equipment are specifically not recommended without additional processing by Melexis for each application.

The information furnished by Melexis is believed to be correct and accurate. However, Melexis shall not be liable to recipient or any third party for any damages, including but not limited to personal injury, property damage, loss of profits, loss of use, interrupt of business or indirect, special incidental or consequential damages, of any kind, in connection with or arising out of the furnishing, performance or use of the technical data herein. No obligation or liability to recipient or any third party shall arise or flow out of Melexis' rendering of technical or other services.

© 2012 Melexis NV. All rights reserved.

For the latest version of this document, go to our website at www.melexis.com

Or for additional information contact Melexis Direct:

Europe, Africa, Asia: America:
Phone: +32 1367 0495 Phone: +1 248 306 5400
E-mail: sales_europe@melexis.com E-mail: sales_usa@melexis.com

ISO/TS 16949 and ISO14001 Certified